

# P-Channel Enhancement-Mode **Vertical DMOS FET**

### **Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>ISS</sub> and fast switching speeds
- Excellent thermal stability
- Integral source-to-drain diode
- High input impedance and high gain

## **Applications**

- Motor controls
- Converters
- **Amplifiers**
- **Switches**
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

## **General Description**

The Supertex VP2110 is an enhancement-mode (normallyoff) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### **Ordering Information**

Part Number	Package Option	Packing		
VP2110K1-G	TO-236AB (SOT-23)	3000/Reel		

-G denotes a lead (Pb)-free / RoHS compliant package. Contact factory for Wafer / Die availablity. Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

## **Product Summary**

BV <sub>DSS</sub> /BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	l <sub>D(ON</sub> (min)
-100V	12Ω	-500mA

## **Absolute Maximum Ratings**

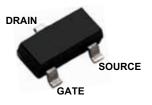
Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	$BV_{DGS}$
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## **Typical Thermal Resistance**

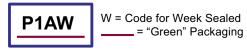
Package	$oldsymbol{ heta}_{ja}$
TO-236AB (SOT-23)	203°C/W

## Pin Configuration



TO-236AB (SOT-23)

## **Product Marking**



Package may or may not include the following marks: Si or TO-236AB (SOT-23)



### **Thermal Characteristics**

Package	l <sub>D</sub> (continuous) <sup>†</sup>	l <sub>D</sub> (pulsed)	Power Dissipation @T <sub>A</sub> = 25°C	l <sub>DR</sub> †	I <sub>DRM</sub>	
TO-236AB (SOT-23)	-120mA	-400mA	0.36W	-120mA	-400mA	

Notes:

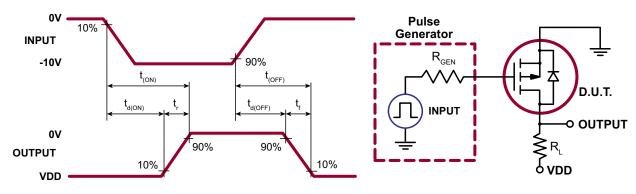
## **Electrical Characteristics** (T<sub>A</sub> = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions		
BV <sub>DSS</sub>	Drain-to-Source breakdown voltage	-100	-	-	V	$V_{GS} = 0V, I_{D} = -1.0 \text{mA}$		
$V_{\rm GS(th)}$	Gate threshold voltage	-1.5	-	-3.5	V	$V_{GS} = V_{DS}$ , $I_D = -1.0$ mA		
$\Delta V_{\text{GS(th)}}$	Change in V <sub>GS(th)</sub> with temperature	-	5.8	6.5	mV/°C	$V_{GS} = V_{DS}$ , $I_{D} = -1.0$ mA		
I <sub>GSS</sub>	Gate body leakage	-	-1.0	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
		-	-	-10	μA	$V_{GS} = 0V, V_{DS} = Max Rating$		
I <sub>DSS</sub>	Zero Gate voltage Drain current	-	-	-1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_A = 125$ °C		
I <sub>D(ON)</sub>	On-state Drain current	-0.5	-1.0	-	Α	$V_{GS} = -10V, V_{DS} = -25V$		
	Static Drain to Source on state registance	-	11	15	Ω	$V_{GS} = -5.0V, I_{D} = -100mA$		
R <sub>DS(ON)</sub>	Static Drain-to-Source on-state resistance		9.0	12	\$2	$V_{GS} = -10V, I_{D} = -500mA$		
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature		0.55	1.0	%/°C	$V_{GS} = -10V, I_{D} = -500mA$		
$G_{FS}$	Forward transductance	150	200	-	mmho	$V_{DS} = -25V, I_{D} = -500mA$		
C <sub>ISS</sub>	Input capacitance	-	45	60		V <sub>GS</sub> = 0V,		
C <sub>oss</sub>	Common Source output capacitance	-	22	30	pF	$V_{DS} = -25V$ ,		
C <sub>RSS</sub>	Reverse transfer capacitance	-	3.0	8.0		f = 1.0MHz		
t <sub>d(ON)</sub>	Turn-on delay time	-	4.0	5.0				
t <sub>r</sub>	Rise time	-	5.0	8.0	ns	$V_{DD} = -25V,$ $I_{D} = -500 \text{mA},$		
t <sub>d(OFF)</sub>	Turn-off delay time	-	5.0	9.0		$R_{GEN} = 25\Omega$		
t <sub>f</sub>	Fall time	-	4.0	8.0		GEN		
V <sub>SD</sub>	Diode forward voltage drop	-	-1.2	-2.0	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -500mA		
t <sub>rr</sub>	Reverse recovery time	-	400	-	ns	$V_{GS} = 0V, I_{SD} = -500 \text{mA}$		

#### Notes:

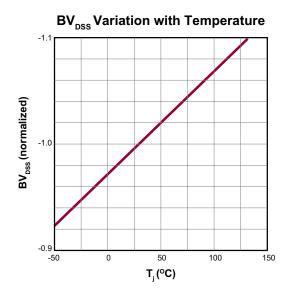
- 1. All D.C. parameters 100% tested at  $25^{\circ}$ C unless otherwise stated. (Pulse test:  $300\mu$ s pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

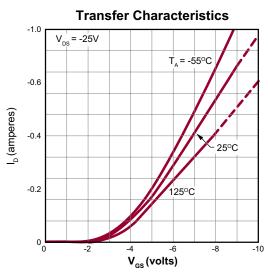
## **Switching Waveforms and Test Circuit**

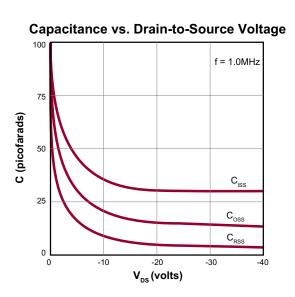


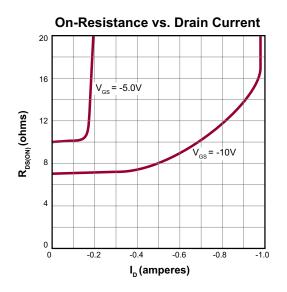
<sup>†</sup>  $I_D$  (continuous) is limited by max rated  $T_P$ 

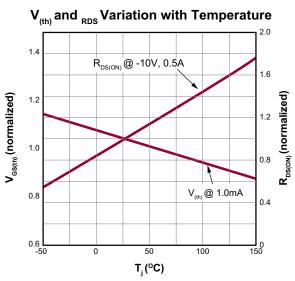
## **Typical Performance Curves**

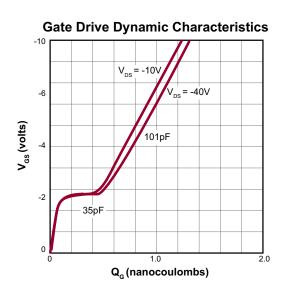




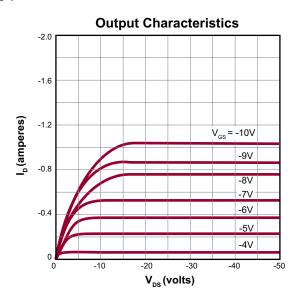


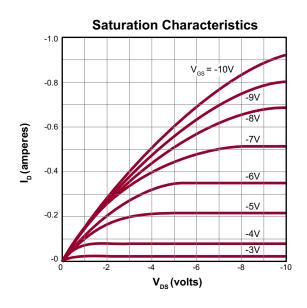




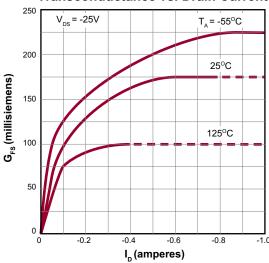


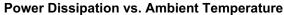
## **Typical Performance Curves** (cont.)

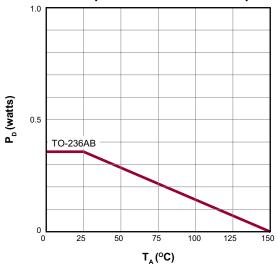




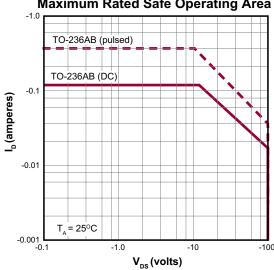
#### Transconductance vs. Drain Current



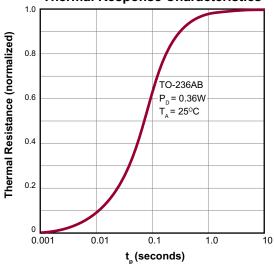




#### **Maximum Rated Safe Operating Area**

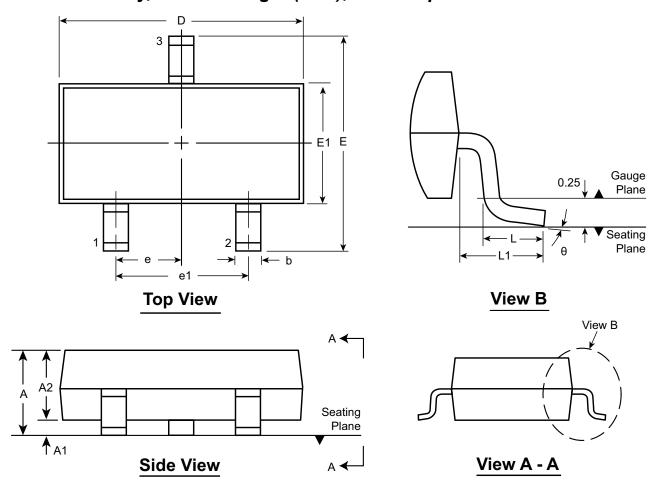


#### **Thermal Response Characteristics**



# 3-Lead TO-236AB (SOT-23) Package Outline (K1)

2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



Symb	ol	Α	A1	A2	b	D	E	E1	е	e1	L	L1	θ			
Dimension (mm)	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.05	1.90 BSC	4.00	4.00		0.20 <sup>†</sup>	0.54	<b>0</b> °
	NOM	-	-	0.95	-	2.90	-	1.30	0.95 BSC		0.50	0.54 REF	-			
	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40	500	500	0.60	111	<b>8</b> °			

JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO236ABK1, Version C041309.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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<sup>†</sup> This dimension differs from the JEDEC drawing.

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